

1703375

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PCB terminal block, nominal current: 4 A, rated voltage (III/2): 160 V, nominal cross section: 0.34 mm², number of potentials: 2, number of rows: 1, number of positions per row: 2, product range: PTQ 0,3/..-THR, pitch: 2.5 mm, connection method: Displacement connection, mounting: THR soldering, conductor/PCB connection direction: 0 °, color: black, Pin layout: Zigzag pinning W, Solder pin [P]: 2 mm, number of solder pins per potential: 1, type of packaging: 32 mm wide tape

Your advantages

- · Connection without conductor pretreatment for huge time savings
- · Finger-operated QUICKON insulation displacement connection enables repeated conductor connection
- · Designed for integration into the SMT soldering process
- · Supplied in tape-on-reel packing according to IEC 60286-3 for automated mounting
- · Anti-rotation pin supports positioning on the PCB
- Satisfies CAT5 requirements in accordance with EN 50173 and ISO/IEC 11801

Commercial data

Item number	1703375
Packing unit	250 pc
Minimum order quantity	250 pc
Sales key	AA11
Product key	AAKKAA
GTIN	4046356649087
Weight per piece (including packing)	2.704 g
Weight per piece (excluding packing)	2.566 g
Customs tariff number	85369010
Country of origin	PL



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Technical data

Product properties

Product type	Printed circuit board terminal
Product family	PTQ 0,3/THR
Product line	COMBICON Terminals XS
Туре	PC termination block
Number of positions	2
Pitch	2.5 mm
Number of connections	2
Number of rows	1
Number of potentials	2
Pin layout	Zigzag pinning W
Solder pins per potential	1

Electrical properties

Nominal current I _N	4 A
Nominal voltage U _N	160 V
Degree of pollution	3
Rated voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	200 V
Rated surge voltage (II/2)	2.5 kV

Connection data

Connection technology

Туре	PC termination block
Nominal cross section	0.34 mm²

Conductor connection

Moisture Sensitive Level

Connection method	Displacement connection
Conductor cross section rigid	0.14 mm² 0.34 mm²
Conductor cross section flexible	0.14 mm² 0.34 mm²
Conductor cross section AWG	26 22

Mounting

Mounting type	THR soldering
Pin layout	Zigzag pinning W
Processing notes	
Process	Reflow/wave soldering

MSL 1



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Classification temperature T _c	260 °C
Solder cycles in the reflow	3

Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	hot-dip tin-plated
Metal surface terminal point (top layer)	Tin (3 - 5 µm Sn)
Metal surface terminal point (middle layer)	Nickel (1.3 - 3 μm Ni)
Metal surface soldering area (top layer)	Tin (3 - 5 µm Sn)
Metal surface soldering area (middle layer)	Nickel (1.3 - 3 μm Ni)

Material data - housing

Color (Housing)	black (9005)
Insulating material	LCP
Insulating material group	Illa
CTI according to IEC 60112	175
Flammability rating according to UL 94	V0

Dimensions

Dimensional drawing	n n
Pitch	2.5 mm
Width [w]	7 mm
Height [h]	10 mm
Length [I]	17.55 mm
Installed height	8 mm
Solder pin length [P]	2 mm
Pin dimensions	0.9 x 0.4 mm
PCB design	
Pin spacing	2.5 mm
Hole diameter	1.1 mm

Mechanical tests

Connection test

Specification	IEC 60998-2-3:2002-12
Result	Test passed



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Pull-out test

Specification	IEC 60999-1:1999-11
Conductor cross section/conductor type/tractive force setpoint/actual value	0.2 mm² / solid / > 10 N
	0.2 mm² / flexible / > 10 N

Electrical tests

Result

Temperature-rise test

Specification	IEC 60998-1:2002-12
Requirement temperature-rise test	Increase in temperature ≤ 45 K
Short-time withstand current	
Specification	IEC 60998-2-3:2002-12
insulation resistance	
Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 MΩ
Temperature cycles	
Specification	IEC 60998-2-3:2002-12

Test passed

Air clearances and creenage distances

Air clearances and creepage distances	
Specification	IEC 60664-1:2007-04
Insulating material group	Illa
Comparative tracking index (IEC 60112)	CTI 175
Rated insulation voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
minimum clearance value - non-homogenous field (III/3)	1.5 mm
minimum creepage distance (III/3)	2.5 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.6 mm
Rated insulation voltage (II/2)	200 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	2 mm

Environmental and real-life conditions

Glow-wire test

Specification	IEC 60998-1:2002-12
Time of exposure	5 s
Shocks	
Specification	IEC 60068-2-27:2008-02



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Pulse shape	Half-sine
Acceleration	15g
Shock duration	11 ms
Test directions	X-, Y- and Z-axis

Ambient conditions

Ambient temperature (operation)	-40 °C 100 °C (Depending on the current carrying capacity/derating curve)
Ambient temperature (storage/transport)	-40 °C 70 °C
Relative humidity (storage/transport)	30 % 70 %
Ambient temperature (assembly)	-5 °C 100 °C

Packaging specifications

Dimensional drawing	
Type of packaging	32 mm wide tape
[W] tape width	32 mm
[W2] coil overall dimension	38.4 mm
[A] coil diameter	330 mm
Outer packaging type	Transparent-Bag
ESD level	(D) electrostatically conductive
Specification	DIN EN 61340-5-1 (VDE 0300-5-1): 2008-07

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Phoenix Contact USA 586 Fulling Mill Road Middletown, PA 17057, United States (+717) 944-1300 info@phoenixcon.com